3.3 V Zero Delay Clock Buffer

The NB2305A is a versatile, 3.3 V zero delay buffer designed to distribute high–speed clocks. It accepts one reference input and drives out five low–skew clocks. It is available in a 8 pin package.

The -1H version of the NB2305A operates at up to 133 MHz, and has higher drive than the -1 devices. All parts have on-chip PLL's that lock to an input clock on the REF pin. The PLL feedback is on-chip and is obtained from the CLKOUT pad.

Multiple NB2305A devices can accept the same input clock and distribute it. In this case the skew between the outputs of the two devices is guaranteed to be less than 700 ps.

All outputs have less than 200 ps of cycle–to–cycle jitter. The input and output propagation delay is guaranteed to be less than 350 ps, and the output to output skew is guaranteed to be less than 250 ps.

The NB2305A is available in two different configurations, as shown in the ordering information table. The NB2305AI is the base part. The NB2305AI1H is the high drive version of the -1 and its rise and fall times are much faster than -1 part.

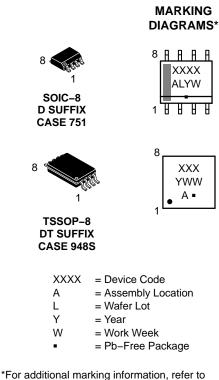
Features

- 15 MHz to 133 MHz Operating Range, Compatible with CPU and PCI Bus Frequencies
- Zero Input Output Propagation Delay
- Multiple Low-Skew Outputs
- Output–Output Skew Less than 250 ps
- Device–Device Skew Less than 700 ps
- One Input Drives 5 Outputs
- Less than 200 ps Cycle-to-Cycle Jitter is Compatible with Pentium® Based Systems
- Accepts Spread Spectrum Clock at the Input
- Available in 8 Pin, 150 mil SOIC Package and 8 Pin TSSOP 4.4 mm
- 3.3 V Operation, Advanced 0.35 µ CMOS Technology
- Guaranteed Across Commercial and Industrial Temperature Ranges
- These are Pb–Free Devices



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Application Note AND8002/D.

ORDERING INFORMATION

See detailed ordering, marking and shipping information in the package dimensions section on page 6 of this data sheet.

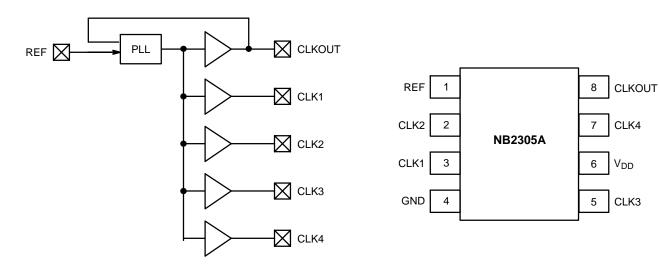


Figure 1. Block Diagram

Figure 2. Pin Configuration

Table 1. PIN DESCRIPTION

Pin #	Pin Name	Description
1	REF (Note1)	Input reference frequency, 5 V tolerant input.
2	CLK2 (Note 2)	Buffered clock output.
3	CLK1 (Note 2)	Buffered clock output.
4	GND	Ground.
5	CLK3 (Note 2)	Buffered clock output.
6	V _{DD}	3.3 V supply.
7	CLK4 (Note 2)	Buffered clock output.
8	CLKOUT (Note 2)	Buffered clock output, internal feedback on this pin.

Weak pulldown.
Weak pulldown on all outputs.

Table 2. MAXIMUM RATINGS

Parameter	Min	Мах	Unit
Supply Voltage to Ground Potential	-0.5	+7.0	V
DC Input Voltage (Except REF)	-0.5	V _{DD} + 0.5	V
DC Input Voltage (REF)	-0.5	7.0	V
Storage Temperature	-65	+150	°C
Maximum Soldering Temperature (10 sec)		260	°C
Junction Temperature		150	°C
Static Discharge Voltage (per MIL–STD–883, Method 3015)		>2000	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 3. RECOMMENDED OPERATING CONDITIONS FOR INDUSTRIAL TEMPERATURE DEVICES

Parameter	Description		Min	Max	Unit
V _{DD}	Supply Voltage		3.0	3.6	V
T _A	Operating Temperature (Ambient Temperature)	Industrial Commercial	-40 0	85 70	°C
CL	Load Capacitance, below 100 MHz			30	pF
CL	Load Capacitance, from 100 MHz to 133 MHz			10	pF
C _{IN}	Input Capacitance			7	pF

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 4. ELECTRICAL CHARACTERISTICS V_{CC} = 3.0 V to 3.6 V, GND = 0 V, T_A = -40° C to $+85^{\circ}$ C

Parameter	Description	Test Conditions	Min	Max	Unit
V _{IL}	Input LOW Voltage (Note 3)			0.8	V
V _{IH}	Input HIGH Voltage (Note 3)		2.0		V
I _{IL}	Input LOW Current	V _{IN} = 0 V		50	μΑ
I _{IH}	Input HIGH Current	V _{IN} = V _{DD}		100	μΑ
V _{OL}	Output LOW Voltage	I _{OL} = 8 mA (-1) I _{OL} = 12 mA (-1H)		0.4	V
V _{OH}	Output HIGH Voltage	I _{OH} = -8 mA (-1) I _{OH} = -12 mA (-1H)	2.4		V
I _{DD}	Supply Current (Commercial Temp)	Unloaded outputs at 66.67 MHz, Select inputs at V_{DD}		34	mA
I _{DD}	Supply Current (Industrial Temp)	Unloaded outputs at 100 MHz 66.67 MHz 33 MHz Select inputs at V _{DD} or GND, at Room Temp		50 34 19	mA

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

3. REF input has a threshold voltage of $V_{DD}/2$.

Parameter	Description		Test Conditions	Min	Тур	Max	Unit
1/t ₁	Output Frequency		30 pF load 10 pF load	15 15		100 133	MHz
1/t ₁	Duty Cycle = $(t_2 / t_1) * 100$	(−1, −1H) (−1H)	Measured at 1.4 V, F _{OUT} = 66.67 MHz < 50 MHz	40 45	50 50	60 55	%
t ₃	Output Rise Time	(–1) (–1H)	Measured between 0.8 V and 2.0 V			2.5 1.5	ns
t ₄	Output Fall Time	(–1) (–1H)	Measured between 2.0 V and 0.8 V			2.5 1.5	ns
t ₅	Output-to-Output Skew		All outputs equally loaded			250	ps
t ₆	Delay, REF Rising Edge to 0 Rising Edge	CLKOUT	Measured at V _{DD} /2		0	±350	ps
t ₇	Device-to-Device Skew		Measured at $V_{DD}/2$ on the CLKOUT pins of the device		0	700	ps
tj	Cycle-to-Cycle Jitter		Measured at 66.67 MHz, loaded outputs			200	ps
t _{LOCK}	PLL Lock Time		Stable power supply, valid clock presented on REF pin			1.0	ms

Table 5. SWITCHING CHARACTERISTICS V_{CC} = 3.0 V to 3.6 V, GND = 0 V, T_A = -40° C to $+85^{\circ}$ C (Note 4)

4. All parameters specified with loaded outputs.

Zero Delay and Skew Control

All outputs should be uniformly loaded to achieve Zero Delay between input and output. Since the CLKOUT pin is the internal feedback to the PLL, its relative loading can adjust the input–output delay. For applications requiring zero input–output delay, all outputs, including CLKOUT, must be equally loaded. Even if CLKOUT is not used, it must have a capacitive load equal to that on other outputs, for obtaining zero–input–output delay.

SWITCHING WAVEFORMS

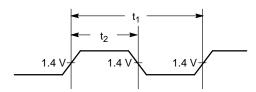


Figure 3. Duty Cycle Timing

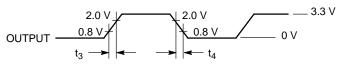
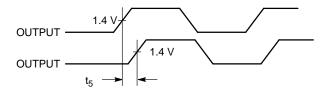
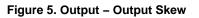


Figure 4. All Outputs Rise/Fall Time





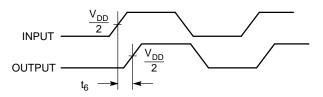


Figure 6. Input – Output Propagation Delay

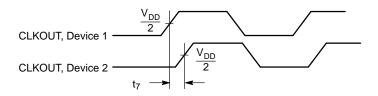
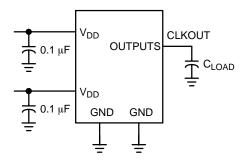


Figure 7. Device – Device Skew

TEST CIRCUITS





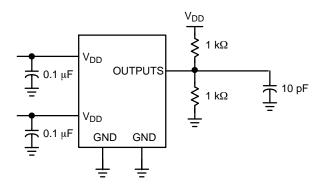


Figure 9. Test Circuit #2 For parameter t_8 (output slew rate) on -1H devices

ORDERING INFORMATION

Device	Marking	Operating Range	Package	Shipping [†]	Availability
NB2305AI1DG	511	Industrial & Commercial	SOIC-8 (Pb-Free)	98 Units / Rail	Now
NB2305AI1DR2G	511	Industrial & Commercial	SOIC-8 (Pb-Free)	2500 Tape & Reel	Now
NB2305AI1HDG	5I1H	Industrial & Commercial	SOIC-8 (Pb-Free)	98 Units / Rail	Now
NB2305AI1HDR2G	5I1H	Industrial & Commercial	SOIC-8 (Pb-Free)	2500 Tape & Reel	Now
NB2305AI1DTG	511	Industrial & Commercial	TSSOP-8 (Pb-Free)	100 Units / Rail	Now
NB2305AI1DTR2G	511	Industrial & Commercial	TSSOP-8 (Pb-Free)	2500 Tape & Reel	Now
NB2305AI1HDTG	5IH	Industrial & Commercial	TSSOP-8 (Pb-Free)	100 Units / Rail	Now
NB2305AI1HDTR2G	5IH	Industrial & Commercial	TSSOP-8 (Pb-Free)	2500 Tape & Reel	Now

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.





*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR 3. 4. EMITTER 5. EMITTER BASE 6. 7 BASE EMITTER 8. STYLE 5: PIN 1. DRAIN 2. DRAIN 3. DRAIN DRAIN 4. GATE 5. 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6 BASE. DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3 GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. DRAIN 8. STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. TXE 4. 5. RXE 6. VFF 7. GND 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 3 CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C REXT З. 4. GND 5. IOUT 6. IOUT IOUT 7. 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. 2 EMITTER, #1 BASE, #2 З. EMITTER, #2 4. 5 COLLECTOR, #2

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 3. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: GROUND PIN 1. BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND 6 BIAS 2 INPUT 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE P-SOURCE 3 P-GATE 4. P-DRAIN 5 6. P-DRAIN N-DRAIN 7. N-DRAIN 8. STYLE 18: PIN 1. ANODE 2. ANODE SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. CATHODE 8. STYLE 22 PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC 4. I/O LINE 3 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt З. ENABLE 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: DRAIN 1 PIN 1. DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 DRAIN, #1 2. DRAIN, #2 З. 4. DRAIN, #2 GATE, #2 5. SOURCE, #2 6. 7 GATE #1 8. SOURCE, #1 STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS THIRD STAGE SOURCE GROUND З. 4. 5. DRAIN 6. GATE 3 SECOND STAGE Vd 7. FIRST STAGE Vd 8. STYLE 11: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. DRAIN 2 DRAIN 1 7. 8. DRAIN 1 STYLE 15: PIN 1. ANODE 1 2. ANODE 1 ANODE 1 3 ANODE 1 4. 5. CATHODE, COMMON CATHODE, COMMON CATHODE, COMMON 6. 7. CATHODE, COMMON 8. STYLE 19: PIN 1. SOURCE 1 GATE 1 SOURCE 2 2. 3. GATE 2 4. 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. **MIRROR 1** STYLE 23: PIN 1. LINE 1 IN COMMON ANODE/GND COMMON ANODE/GND 2. 3 LINE 2 IN 4. LINE 2 OUT 5. COMMON ANODE/GND COMMON ANODE/GND 6. 7. LINE 1 OUT 8. STYLE 27: PIN 1. ILIMIT 2 OVI 0 UVLO З. 4. INPUT+ 5. SOURCE SOURCE 6. SOURCE 7. 8 DRAIN

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STYLE 4: PIN 1. 2. ANODE ANODE ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE, #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE 2. 3. GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE 2. EMITTER 3 COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE 6. CATHODE COLLECTOR/ANODE 7. 8. COLLECTOR/ANODE STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8 VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

COLLECTOR, #2

COLLECTOR, #1

COLLECTOR, #1

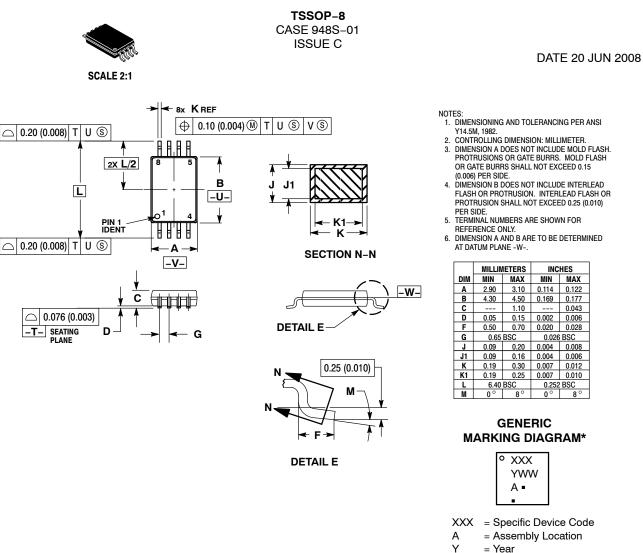
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С	REMOVED EXPOSED PAD VIEW AND DIMENSIONS P AND P1. CORRECTED MARKING INFORMATION. REQ. BY C. REBELLO.	20 JUN 2008		

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